



Accura[®] Sapphire

Specialty Class

High-resolution material for accurate master patterns for jewelry manufacturing

Post-Cured Material

MEASUREMENT	CONDITION	VALUE	U.S.
Tensile Strength (MPa/PSI)	ASTM D 638	20-24	9280-9720
Tensile Modulus (MPa/KSI)	ASTM D 638	910-1110	406-577
Elongation at Break (%)	ASTM D 638	9-16	4-7
Flexural Strength (MPa/PSI)	ASTM D 790	28-38	15200-17100
Flexural Modulus (MPa/KSI)	ASTM D 790	1080-1420	400-493
Impact Strength (J/m /Ft-lbs/in)	ASTM D 256	29-40	0.4-0.5
Heat Deflection Temperature	ASTM D 648 @ 66 PSI @ 264 PSI	38 °C 33 °C	100 °F 91 °F
Coefficient of Thermal Expansion (µm/m-°C / µm/in-°F)	ASTM E 831-93 TMA (T<T _g , 25-50 °C)	135	75
	TMA (T<T _g , 75-140 °C)	165	92
Glass Transition (T _g)	DMA, E''	51 °C	124 °F
Hardness, Shore D		72	72

Features

- Accurate high-resolution master patterns
- High resolution in X, Y and Z dimensions
- Manufacture master patterns for jewelry and other microcasting applications
- Low ash formation

Liquid Material

MEASUREMENT	CONDITION	VALUE
Viscosity	@ 30 °C (86 °F)	138 cps
Penetration Depth (D _p)		2.9 mils
Critical Exposure (E _c)		8.23 mJ/cm ²
Color		Sapphire Blue
Solid Density	@ 25 °C (77 °F)	1.18 g/cm ³ at 25 °C
Liquid Density	@ 25 °C (77 °F)	1.1 g/cm ³ at 25 °C



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